Transient Voltage Suppression Diodes SMTO-218 - 6 kA > LTKAK6 series

LTKAK6 Series













Agency Approvals

AGENCY	AGENCY FILE NUMBER
71 2	E129662

Maximum Ratings and Thermal Characteristics (T_a=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Operating Junction and Storage Temperature Range	$T_{J_{J}}T_{STG}$	(-)40 to 125	°C
Current Rating ¹	l _{PP}	6	kA

Note:

Description

The LTKAK6 series offers superior clamping characteristics over standard S.A.D. technologies by virtue of the Littelfuse Foldbak technology, which provides a clamping voltage lower than the avalanche voltage (but above the rated working voltage). Therefore, any voltage rise due to increased current conduction is contained to a minimum, providing the best possible protection level. This LTKAK6 series can be combined in series or parallel solutions to offer various clamping levels and surge withstand options.

The LTKAK6 SMT package provides a more compact PCB layout than typical through-hole TO-218 AKTVS components.

Features

- High Power TVS designed in a surface mount and compact SMTO-218 package
- Patent pending package design
- Foldbak Technology for superior clamping characteristics
- Tube or tape and reel pack options available
- Ideal for automatic pick and place assembly and reflow process to reduce the manufacturing cost and increase the soldering quality as

- compared to axial leaded packages
- · Low clamping and slope resistance.
- Sharp breakdown voltage.
- Meet MSL level1, per J-STD-020, LF maximum peak of 260°C
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/JEDEC J-STD-609A.01)
- UL Recognized compound meeting flammability rating V-0

Electrical Characteristics (T_a=25°C unless otherwise noted)

Part Numbers	Standoff Voltage (V _{so}) (V)	Max. Reverse Leakage (I _R) @V _{so}	Reverse Breakdown Voltage (V _{BR}) @ I _T		Test Current I _T	Max. Clamping Voltage V _C @ (I _{PP})	Max. Temp Coefficient of V _{BR}	Max. Capacitance 0V Bias 10kHz
		΄(μΑ)	Min Volts	Max Volts	(mA)	Volts	(%/°C)	(nF)
LTKAK6-058C	58	10	64	70	10	110	0.1	6.5
LTKAK6-066C	66	10	72	80	10	120	0.1	5.5
LTKAK6-076C	76	10	85	95	10	140	0.1	4.5

Note: Using 8/20 waveshape as defined in IEC 61000-4-5 2nd edition.

Surge Ratings

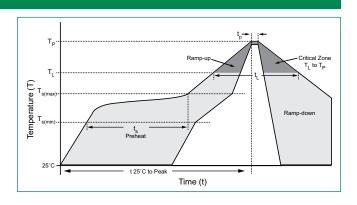
Part Numbers	Max Peak Pulse Current (I _{PP})			
	(80/20µS) (A)	(10/350µS) (A)	(10/1000µS) (A)	
	Min	Min	Min	
LTKAK6-058C	6,000	900	430	
LTKAK6-066C	6,000	900	430	
LTKAK6-076C	6,000	900	430	

^{1.} Rated min I_{DD} measured with 8/20µs pulse.



Soldering Parameters

Reflow Condition		Lead-free assembly
	-Temperature Min (T _{s(min)})	150°C
Pre Heat	-Temperature Max (T _{s(max)})	200°C
	-Time (min to max) (t _s)	60 – 180 secs
Average ra to peak	mp up rate (Liquidus Temp (T _A)	3°C/second max
$T_{S(max)}$ to T_A	- Ramp-up Rate	3°C/second max
Reflow	-Temperature (T _A) (Liquidus)	217°C
nellow	-Time (min to max) (t _s)	60 – 150 seconds
Peak Temp	erature (T _P)	260 ^{+0/-5} °C
Time within 5°C of actual peak Temperature (t,)		20 - 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T _P)		8 minutes Max.
Do not exc	eed	260°C



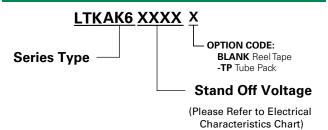
Flow/Wave Soldering (Solder Dipping)

Pea	k Temperature :	265°C
Dip	ping Time :	10 seconds
Solo	dering :	1 time

Physical Specifications

Weight	Contact manufacturer		
Case	Epoxy encapsulated		
Terminal	Tin plated lead, solderable per MIL-STD-202 Method 208		

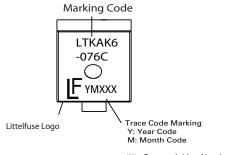
Part Numbering System



Physical Specifications

High Temp Storage	JESD22-A103
HTRB	JESD22-A108
MSL	JESDEC-J-STD020, Level 1
H3TRB	JESD22-A101
RSH	JESD22-B106

Part Marking System

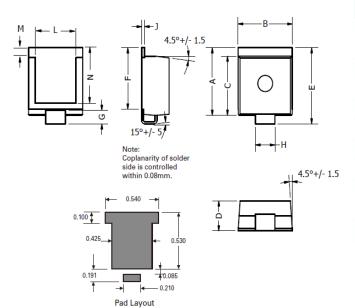


XXX : Sequential Lot Number

Transient Voltage Suppression Diodes SMT0-218 - 6 kA > LTKAK6 series

Dimensions — SMTO-218

Note: Coplanarity of solder side is controlled within 0.08mm.

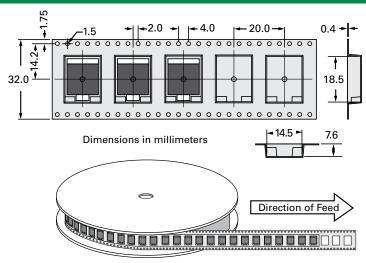


Dimension	Inches		Millimeters	
Dimension	Min	Max	Min	Max
А	0.621	0.655	15.78	16.63
В	0.529	0.594	13.43	15.09
С	0.544	0.561	13.83	14.24
D	0.273	0.285	6.94	7.24
Е	0.702	0.737	17.82	18.72
F	0.567	0.587	14.40	14.90
G	0.087	0.126	2.20	3.20
Н	0.193	0.222	4.89	5.65
J	0.028	0.033	0.72	0.85
L	0.400	0.440	10.17	11.17
М	0.073	0.112	1.85	2.85
N	0.510	0.533	12.95	13.55

Packaging

Part Number Weight		Packing Mode	Base Quantity	
LTKAK6-xxxC	4.34g	Tape & Reel – 32mm/13" tape	400	
LTKAK6-xxxC-TP	4.34g	Tube Pack	100(25/Tube)	

Tape and Reel Specification



Transient Voltage Suppression Diodes SMTO-218 - 10KA > LTKAK10 series

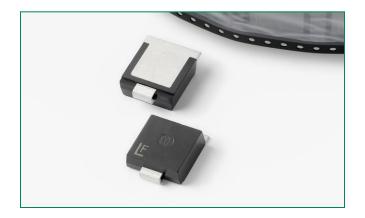
LTKAK10 Series











Agency Approvals

AGENCY	AGENCY FILE NUMBER
71	E129662

Maximum Ratings and Thermal Characteristics (T_a=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Operating Junction and Storage Temperature Range	T_{J},T_{STG}	(-)40 to 125	°C
Current Rating ¹	I _{PP}	10	kA

Note:

1. Rated min I_{ss} measured with 8/20µs pulse

Description

The LTKAK10 series offer superior clamping characteristics over standard S.A.D. technologies by virtue of the Littelfuse Foldbak technology, which provides a clamping voltage lower than the avalanche voltage (but above the rated working voltage). Therefore, any voltage rise due to increased current conduction is contained to a minimum, providing the best possible protection level. They can also be connected in series and/or parallel to create various capability and flexible protection solutions.

LTKAK10 in SMTO-218 package provide the enhanced quality, easy manufacturing and compact mechanical design than current AKTVS families.

Features

- Compact design having the Hi Power TVS in surface mount package
- Patent pending package design
- Foldbak Technology for superior clamping factor
- Option for pack in tube or tape and reel.
- Ideal for automatic pick and place assembly and reflow process to reduce the manufacturing cost and increase the soldering quality compared to axial leads package

- Low clamping and slope resistance.
- Sharp breakdown voltage.
- Halogen free and RoHS compliant
- 2nd level interconnect is Pb-free (IPC/JEDEC J-STD-609A.01)
- Plastic package has underwriters laboratory flammability classification 94V-O

Electrical Characteristics

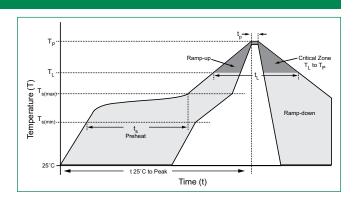
Part	Standoff Max. Reverse	Reverse Breakdown Voltage (V _{BR}) @ I _T		Test Current I _T	Max. Clamping Voltage V _{CL} @ Peak Pulse Current (I _{PP})				Max. Temp Coefficient of V _{BR}	Max. Capacitance 0 Bias 10kHz		
Numbers	(V _{so}) (V)	Leakage (I _R) @V _{so} (µA)	Min Volts	Max Volts	(mA)	V _{CL} Volts	l _F (8/20 (<i>F</i> min	ĎμS)	_{pp} (10/350μS) (A) min typ		(%/°C)	(nF)
LTKAK10-058C	58	10	64	70	10	110	10,000	-	-	-	0.1	8.5
LTKAK10-066C	66	10	72	80	10	120	10,000	13,000	800	-	0.1	7.5
LTKAK10-076C	76	10	85	95	10	140	10,000	12,000	450	-	0.1	6.5

Note: Using 8/20µS wave shaped defined in IEC 61000-4-5.



Soldering Parameters

Reflow Co	ndition	Lead-free assembly		
	-Temperature Min (T _{s(min)})	150°C		
Pre Heat	-Temperature Max (T _{s(max)})	200°C		
	-Time (min to max) (t _s)	60 – 180 secs		
Average ra to peak	mp up rate (Liquidus Temp (T _A)	3°C/second max		
$T_{S(max)}$ to T_A	- Ramp-up Rate	3°C/second max		
Reflow	-Temperature (T _A) (Liquidus)	217°C		
	-Time (min to max) (t _s)	60 – 150 seconds		
Peak Temp	erature (T _P)	260 ^{+0/-5} °C		
Time withi Temperatu	n 5°C of actual peak re (t _p)	20 - 40 seconds		
Ramp-dow	n Rate	6°C/second max		
Time 25°C	to peak Temperature (T _P)	8 minutes Max.		
Do not exc	eed	260°C		



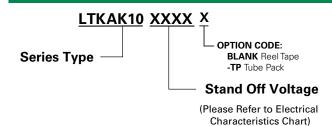
Flow/Wave Soldering (Solder Dipping)

Peak Temperature :	265°C		
Dipping Time :	10 seconds		
Soldering :	1 time		

Physical Specifications

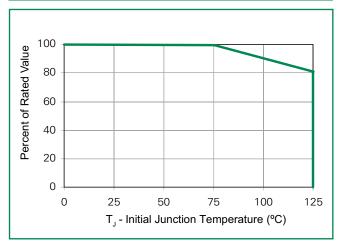
Weight	Contact manufacturer		
Case	Epoxy encapsulated		
Terminal	Tin plated lead, solderable per MIL-STD-202 Method 208		

Part Numbering System



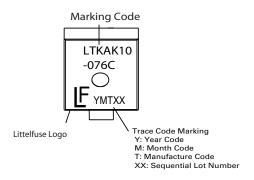
Ratings and Characteristic Curves (T_A=25°C unless otherwise noted)

Peak Power Derating



Please contact Littelfuse for reliability or FIT/MTBF data , the performance is subject to vary and depends on the end customers' application condition.

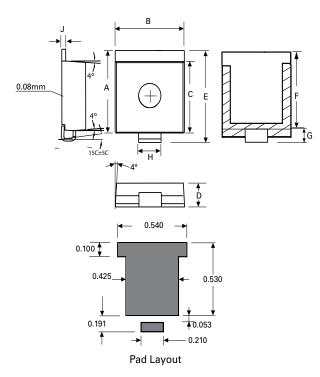
Part Marking System



Transient Voltage Suppression Diodes SMT0-218 - 10KA > LTKAK10 series

Dimensions — SMTO-218 Tab

Note: Coplanarity of solder side is controlled within 0.08mm.



Dimension	Incl	nes	Millimeters		
Dimension	Min Max		Min	Max	
А	0.621	0.655	15.78	16.63	
В	0.529	0.594	13.43	15.09	
С	0.544	0.561	13.83	14.24	
D	0.273	0.285	6.94	7.24	
Е	0.702	0.737	17.82	18.72	
F	0.567	0.581	14.40	14.76	
G	0.074	0.104	1.88	2.64	
Н	0.193	0.222	4.89	5.65	
J	0.028	0.033	0.72	0.85	

Packaging

Part Number	Weight	Packing Mode	Base Quantity
LTKAK10-xxxC	4.34g	Tape & Reel – 32mm/13" tape	400
LTKAK10-xxxC-TP	4.34g	Tube Pack	100(25/Tube)

Tape and Reel Specification

